

Application Report SLAA139A–February 2002–Revised May 2018

# Implementing An Ultra-Low-Power Keypad Interface With MSP430<sup>™</sup> MCUs

MSP430 Applications

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### ABSTRACT

In applications with keypads, a key can be held or stuck down, which causes excess current consumption and reduces the battery life of a battery-operated product. This application report describes a solution. The keypad interface in this report, based on the MSP430F123 microcontroller (MCU), draws 0.1  $\mu$ A while waiting for a key press, is interrupt driven, requires no polling, and consumes a maximum of only 2  $\mu$ A at 3 V if all keys are pressed and held simultaneously.

The source code described in this application report can be downloaded from http://www.ti.com/lit/zip/slaa139.

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## 1 Introduction

The keypad interface described in this report (see Figure 1) is based on the MSP430F123 MCU. Features of this design include:

- 100-nA typical current consumption while waiting for key press
- 2-µA maximum current consumption if all keys are held simultaneously
- No polling required
- No crystal required
- Minimum external components
- Suitable for any MSP430<sup>™</sup> MCU



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### 2 Implementation

The rows of the keypad are connected to port pins P3.0 to P3.3. The columns are connected to pins P1.0 to P1.2. Connecting the rows to port 3 pins, instead of port 1 pins, leaves the other port 1 pins for other interrupt sources, because the P1 pins have interrupt capability, but the P3 pins do not.

In normal mode, while the circuit is awaiting a key press (wait-for-press mode), the rows are driven high, and the P1.x column pins are configured as inputs, with interrupts enabled and set to interrupt on a rising edge. The 4.7-M $\Omega$  pulldown resistors hold the inputs low in this state. The MCU then enters low-power mode 4 (LPM4), in which the MCU current consumption is approximately 100 nA. This state is maintained indefinitely until a key is pressed. The circuit is interrupt-driven with no need for polling.



Figure 1. Keypad Schematic Diagram



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When a key is pressed, the column associated with that key receives a rising edge, waking the MSP430 MCU. At that time, Timer\_A is configured to perform a debounce delay of approximately 40 ms. The timer for the delay uses the internal digitally controlled oscillator (DCO) of the MSP430 MCU, which is an RC-type oscillator. The DCO is subject to tolerances, so a debounce delay was chosen to give a worst-case-minimum delay of 25 ms. That translates to a worst-case maximum delay of approximately 86 ms and a typical delay of approximately 40 ms. This is a useable range for keypad debounce.

After a key has been pressed, the MCU enters a wait-for-release mode in which it drives high only the necessary row for the key being pressed (other rows are driven low). The software reconfigures the P1.x I/O lines to interrupt on a falling edge, and the MCU returns to LPM4, waiting for the release of the key. Again, there is no polling necessary. The detection of the key release is interrupt driven, which allows the microcontroller to stay in LPM4 while the key is held, thus reducing current consumption. When the key is released, the debounce delay is again executed. After the debounce delay, the keypad is scanned again to determine if any other keys are being held. If so, the wait-for-release mode continues, waiting for all keys to be released. When all keys are released, the MSP430 MCU returns to the wait-for-press mode.

During the wait-for-release mode, only one row of the keypad is driven high, therefore limiting the maximum amount of current consumption to the condition where all three keys on a single row are pressed and held. For a 3-V system, that equates to approximately 2  $\mu$ A. Any other key press does not result in increased current consumption, because the corresponding row is not driven high.

In this 3×4 keypad example, the rows are driven rather than the columns to limit the maximum current consumption by the circuit when all keys are pressed and held simultaneously. If the columns were driven instead, the rows would have had the pulldown resistors, therefore increasing the number of paths to ground when all the keys are held and increasing the possible current consumption.



#### Software

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#### 3 Software

Figure 2 shows the software flow. The complete code listing follows and is can be downloaded from http://www.ti.com/lit/zip/slaa139.



Figure 2. Software Flow

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; of 2uA in the even the keys are accidentally pressed and held. The circuit ; is completely interrupt driven, requires no polling, and requires no ; external crystal. : Mike Mitchell ; ; MSP430 Applications Texas Instruments, Inc ; ; January, 2002 ; RSEG CSTACK ; System stack DS 0 RSEG UDATA0 ; RAM Locations ; \* \* \* \* \* \* \* \* \* \* \* \* NoKey EQU 01h NoMatch EQU 02h Error\_Flags DS 1 ; Error Flags ; xxxx xxxx ; ||-- No Key being depressed ; ; |---- No key match found RSEG CODE ; Program code Reset mov #SFE(CSTACK),SP ; Initialize stackpointer SetupWDT mov #WDTPW+WDTHOLD,&WDTCTL ; Stop WDT SetupPorts mov.b #0F8h,&P1DIR ; Unused P1.x as Outputs mov.b #0FFh,&P2DIR ; Unused P2.x as outputs ; All P3.x as outputs mov.b #0FFh,&P3DIR eint ; Enable Interrupts SetupDCO mov.b #0,&BCSCTL1 ; Set Rsel=0, leave DCO=3 ; This gives nom MCLK of ; 130KHz at 3V, 25C. Mainloop call #Set\_For\_Press ; Setup to wait for key press bis #LPM4,SR ; Wait for key press call #Debounce ; Call debounce delay call #KeyScan ; Scan Keypad bit.b #NoKey,Error\_Flags ; Test if no key was depressed jnz Mainloop ; False interrupt, no key pressed call #KeyLookup ; Lookup Key value call #Wait\_For\_Release ; Wait for key(s) to be released jmp Mainloop ; Set\_For\_Press ; Setup to wait for key press bis.b #BIT0+BIT1+BIT2+BIT3,&P3OUT ; Enable keypad bic.b #BIT0+BIT1+BIT2,&P1IES ; L-to-H interrupts clr.b &P1IFG ; Clear any pending flags mov.b #BIT0+BIT1+BIT2,&P1IE ; Enable interrupts



Software

	clr.b	Error_Flags	; Clear error flags
_	ret		
Debounce	; Debounce	Delay Routine	
, SetupTA	mov	#TASSEL1+TACLR,&TACTL	; SMCLK, Clear TA
	mov	#CCIE,&TACCTL0	; Enable CCR0 interrupt
	mov	#5125,&TACCR0	; Value for typ delay of ~40mS
	bis	#MC0,&TACTL	; Start TA in up mode
	bis	#LPM0,SR	; Sleep during debounce delay
	ret		; Return
; KeyScan	; Keypad	Routine	
;			
#derine	KeyMask	RI5	
#derine	LoopCount	R14	
#define	KeyHex	R13	
#define	KeyVal	R5	
	mov	#1,KeyMask	; Initialize scan mask
	mov	#4,LoopCount	; Initialize loop counter
	clr	KeyHex	; Clear register
	bic.b	#07h,&P1OUT	; Clear column bits in PlOUT req
Scan 1	bic.b	#0Fh,&P3OUT	; Stop driving rows
—	bis.b	#07h,&P1DIR	; Set column pins to output and low
	bic.b	#07h.&P10UT	; To bleed off charge and avoid
	21012	10,11,012001	; erroneous reads
	bic.b	#07H.&P1DIR	; Set column pins back to input
	Mov b	KevMask &P30IIT	; Drive row
	hit b	$\pm 7h$ & P1 TN	: Test if any key pressed
	jz	$\pi$ ,	; No key pressed
	J2 bic b	KeyMack KeyHey	; If yes, set bit for row
	mov b	CDITN P12	; Read golumn inputs
	and b	407b $p12$	: Clear unuged bits
	alla.b	#07H,KIZ	, clear unused bits
	rla.b	RIZ	/
	ria.b	RIZ D10	, Rotate Column bit
	ria.b	RIZ	i
	rla.b	R12	;
	bis.b	R12,KeyHex	; Set column bit in KeyHex
Scan_2	rla.b	KeyMask	; Rotate mask
	dec	LoopCount	; Decrement counter
	jnz	Scan_1	; Continue scanning if not done
: Check t	o see if an	w key is being pressed	If not set flag and return
, CIICCA L		KevHey	: Test Kevilley
	ing	EndSaan	· If not 0 roturn
	JIIZ bia b	HIGSCAIL	, II NOU U FELUIN . Cot flog
	0.210	#NOKEY,Error_Flags	, Set IIag
EndScan	bis.b	#0Fh,&P3OUT	; Drive rows again
:	ret		
, KeyLookup	o ; Table	look-up to determine w	hat key was pressed.
,	mov	#10,KeyVal	; Initial key value
qoolyool	cmp.b	Key_Tab(R5),KevHex	; Compare
	jea	EndLU	; If equal end look-up
	767		olaar one room ab

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KeyVal dec ; decrement pointer/counter jnz LookLoop ; Continue until find key or ; count to zero. EndError ; If get here, Did not find match, so more than one key is pressed. ; return error condition bis.b #NoMatch,Error\_Flags ; Set Error Flag ret ; Return EndLU ; Done with Key look-up - found key successfully. dec KeyVal ; Adjust because using same ; register for key counter ; and table pointer ; --> The key that was pressed is now in R5. The applicaion ; can now move it for furthur handling, display, etc. ; This example doesn't actually do anything with the key information. ret ;-----; Setup to wait for key release Wait For Release ; Isolate one row that is in use mov.b #1,R11 ; row counter L\$1 and.b #0Fh,KeyHex ; And off column info in KeyHex KeyHex ; Rotate row info through C rrc jc proceed ; Looking for a '1' rla R11 ; Shift to next bit and jmp L\$1 ; continue looking inv.b proceed R11 ; Invert #0Fh,R11 and ; Clear upper bits bic.b R11,&P3OUT ; Turn off all but one row ; Setup for interrupt on key release bis.b #07h,&P1DIR ; Set column pins to output and low bic.b #07h,&P1OUT ; To bleed off charge and avoid ; erroneous reads bic.b#07H,&P1DIR; Set column pinbis.b#07h,&P1IES; H-L Interruptsclr.b&P1IFG; Clear any pend ; Set column pins back to input ; Clear any pending flags bis.b #07h,&P1IE ; Enable Interrupts bis #LPM4,SR ; Sleep waiting for release Call #Debounce ; Debounce release of key call #KeyScan ; Scan keypad again bit.b #NoKey,Error\_Flags ; Test if any key pressed Wait\_For\_Release ; If so, repeat jz End\_Wait bic.b #NoKey,Error\_Flags ; Clear flag ; Return ret ;-----P1ISR ; P1.x Interrupt service Routine #LPM4,0(SP) ; Return active bic clr.b &P1IFG ; Clear interrupt flag clr.b &P1IE ; Disable furthur P1 interrupts reti CCR0\_ISR ; CCR0 Interrupt Service Routine 

Software



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	bic mov clr reti	#LPM0,0(SP) #TACLR,&TACTL &TACCTL0	; Return Active ; Stop and clear TA ; Clear CCTL0 register
, Key_Tab	; Key look	-up table	
;	DB	00h ; Dummy value. ; both table po	Allows use of same register for ointer and key counter
	DB	028h ; '0' key	-
	DB	011h ; '1' key	
	DB	021h ; '2' key	
	DB	041h ; '3' key	
	DB	012h ; '4' key	
	DB	022h ; '5' key	
	DB	042h ; '6' key	
	DB	014h ; '7' key	
	DB	024h ; '8' key	
	DB	044h ; '9' key	
;	COMMON	INTVEC	; Interrupt vectors
;			
	ORG	RESET_VECTOR	
	DW	Reset	
	ORG	TIMERA0_VECTOR	
	DW	CCR0_ISR	
ORG PORT1_VECTOR			
_	DW	P1ISR	
;	END		



Low-Power Implementation on MSP430 FRAM MCUs

#### 4 Low-Power Implementation on MSP430 FRAM MCUs

These resources give additional information about keypad applications based on the MSP430 FRAMbased microcontrollers:

Low-Power Hex Keypad Using MSP430 MCUs implements a completely interrupt-driven approach with minimal use of external components.

Infrared (IR) BoosterPack Plug-In Module includes a low-power hex keypad implementation.

MSP430 Capacitive Sensing Microcontrollers enable capacitive-touch keypad implementations.



# **Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Cł	Changes from February 5, 2002 to May 22, 2018 P		
•	Editorial changes throughout document	1	
•	Added Section 4, Low-Power Implementation on MSP430 FRAM MCUs	. 10	

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